

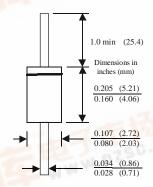
Discrete POWER & Signal Technologies

RGP10A - RGP10M

Features

- 1.0 ampere operation at T_A = 55°C with no thermal runaway.
- High temperature metallurgically bonded construction.
- Glass passivated cavity-free junction.
- Typical I_R less than 1μA.
- Fast switching for high efficiency.





1.0 Ampere Glass Passivated Fast Recovery Rectifiers

Absolute Maximum Ratings*

T_A = 25°C unless otherwise noted

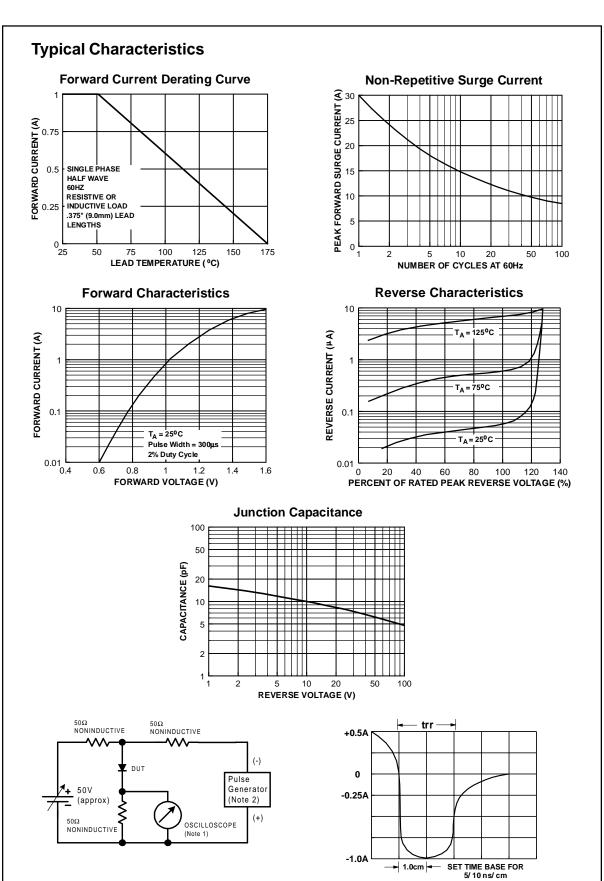
Symbol	Parameter	Value	Units
lo	Average Rectified Current .375 " lead length @ T _L = 55°C	1.0	A
İf(surge)	Peak Forward Surge Current 8.3 ms single half-sine-wave Superimposed on rated load (JEDEC method)	30	W.O.ASC.GO
P _D	Total Device Dissipation Derate above 25°C	2.5 17	W mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	50	°C/W
T _{stg}	Storage Temperature Range	-65 to +175	°C
TJ	Operating Junction Temperature	-65 to +175	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Electrical Characteristics

T_A = 25°C unless otherwise noted

Parameter	Device						Units	
	10A	10B	10D	10G	10J	10K	10M	
Peak Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	35	70	140	280	420	560	700	V
DC Reverse Voltage (Rated V _R)	50	100	200	400	600	800	1000	V
Maximum Reverse Current @ rated V_R $T_A = 25^{\circ}C$ $T_A = 150^{\circ}C$	5.0 200							μA μA
Maximum Reverse Recovery Time $I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$	150 250 500						nS	
Maximum Forward Voltage @ 1.0 A	1.3							V
Typical Junction Capacitance $V_R = 4.0 \text{ V}, f = 1.0 \text{ MHz}$	15					pF		



Reverse Recovery Time Characterstic and Test Circuit Diagram

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